

Discription

The ESD5L5.0C protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD. It gives designer the flexibility to protect one bi-directional

It gives designer the flexibility to protect one bi-directiona line in applications where arrays are not practical.



SOD-523

Specification Features:

- ★ Ultra Low Capacitance 0.6 pF
- ★ Low Clamping Voltage
- ★ Small Body Outline Dimensions: 0.047" x 0.032" (1.20 mm x 0.80 mm)
- ★ Low Body Height: 0.016" (0.4 mm)
- ★ Stand-off Voltage: 5 V
- ★ Low Leakage
- ★ Response Time is Typically < 1.0 ns
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ This is a Pb-Free Device



Circuit Diagram

Ordering information

Product ID	Pack	Qty(PCS)
ESD5L5.0C	SOD-523	3000

Absolute Ratings (T_{amb}=25°C)

C (and)						
Symbol	Parameter	Value	Units			
P_{PP}	Peak Pulse Power (t _p = 8/20 μ s)		60	W		
T _L	Maximum lead temperature for soldering during 10s	260	°C			
T _{stg}	Storage Temperature Range		-55 to +155	°C		
T _{op}	Operating Temperature Range		-40 to +125	°C		
Tj	Maximum junction temperature		150	°C		
	IEC61000-4-2 (ESD)	air discharge	±10	KV		
	cont	act discharge	± 10	IXV		

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0*0.75*0.62 in.



ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted

	V _{RWM} (V)	I _R (μΑ) @ V _{RWM}	V _{BR} (V) @ I _T (Note 2)	ŀт	C (pF)	V _C (V) @ I _{PP} = 3 A (Note 3)	P _{PK} (W)*	v _c
Device	Max	Max	Min	mA	Тур	Max	Max	Per IEC61000-4-2 (Note 4)
ESD5L5.0C	5.0	1.0	5.4	1.0	0.6	15	45	Figures 1 and 2 See Below

- V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.
 Surge current waveform per Figure 5.
 For test procedure see Figures 3 and 4.

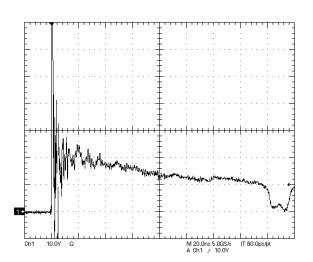


Figure 1. ESD Clamping Voltage Screenshot Positive 8 kV Contact per IEC61000-4-2

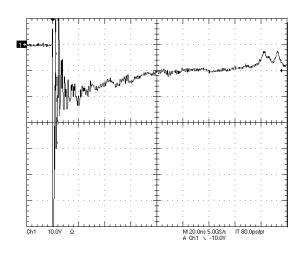


Figure 2. ESD Clamping Voltage Screenshot Negative 8 kV Contact per IEC61000-4-2

IEC 61000-4-2 Spec.

Level	Test Voltage (kV)	First Peak Current (A)	Current at 30 ns (A)	Current at 60 ns (A)
1	2	7.5	4	2
2	4	15	8	4
3	6	22.5	12	6
4	8	30	16	8

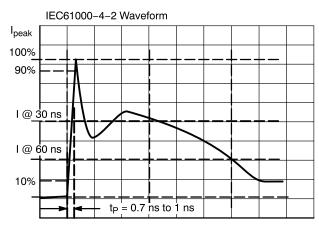
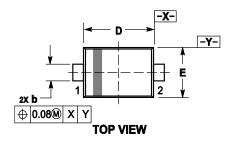
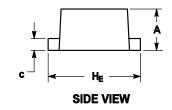


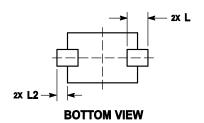
Figure 3. IEC61000-4-2 Spec



OUTLINE AND DIMENSIONS





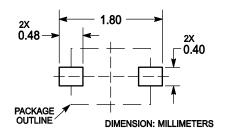


Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.50	0.60	0.70	0.020	0.024	0.028	
b	0.25	0.30	0.35	0.010	0.012	0.014	
С	0.07	0.14	0.20	0.003	0.006	0.008	
D	1.10	1.20	1.30	0.043	0.047	0.051	
Е	0.70	0.80	0.90	0.028	0.031	0.035	
H _E	1.50	1.60	1.70	0.059	0.063	0.067	
L	0.30 REF			0	.012 RE	F	
L ₂	0.15	0.20	0.25	0.006	0.008	0.010	

SOLDERING FOOTPRINT





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